SLOVENSKI STANDARD
SIST EN IEC 60917-1:2020

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Nadomešča:
SIST EN 60917-1:2002
SIST EN 60917-1:2002/A1:2002

Razpored modulov za razvoj mehanske zgradbe elektronske opreme - 1. del: Osnovni standard (IEC 60917-1:2019)

Modular order for the development of mechanical structures for electronic equipment practices - Part 1: Generic standard (IEC 60917-1:2019)

Modulordnung für die Entwicklung von Bauweisen für elektronische Einrichtungen - Teil 1: Fachgrundnorm (IEC 60917-1:2019)

Ordre modulaire pour le développement des structures mécaniques pour les infrastructures électroniques - Partie 1: Norme générique (IEC 60917-1:2019)

Ta slovenski standard je istoveten z: **EN IEC 60917-1:2019**

ICS:

31.240	Mehanske konstrukcije za elektronsko opremo	Mechanical structures for electronic equipment

SIST EN IEC 60917-1:2020 **en**

EUROPEAN STANDARD

NORME EUROPÉENNE

EUROPÄISCHE NORM

EN IEC 60917-1

November 2019

ICS 31.240

Supersedes EN 60917-1:1998 and all of its amendments and corrigenda (if any)

English Version

Modular order for the development of mechanical structures for electrical and electronic equipment practices - Part 1: Generic standard (IEC 60917-1:2019)

Ordre modulaire pour le développement des structures mécaniques pour les infrastructures électriques et électroniques - Partie 1: Norme générique (IEC 60917-1:2019)

Modulordnung für die Entwicklung von Bauweisen für elektrische und elektronische Einrichtungen - Teil 1: Fachgrundnorm (IEC 60917-1:2019)

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Up-to-date lists and bibliographical references concerning such national standards may be obtained on application to the CEN-CENELEC Management Centre or to any CENELEC member.

This European Standard exists in three official versions (English, French, German). A version in any other language made by translation under the responsibility of a CENELEC member into its own language and notified to the CEN-CENELEC Management Centre has the same status as the official versions.

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European Committee for Electrotechnical Standardization
Comité Européen de Normalisation Electrotechnique
Europäisches Komitee für Elektrotechnische Normung

CEN-CENELEC Management Centre: Rue de la Science 23, B-1040 Brussels

European foreword

The text of document 48D/703/FDIS, future edition 2 of IEC 60917-1, prepared by SC 48D "Mechanical structures for electrical and electronic equipment" of IEC/TC 48 "Electrical connectors and mechanical structures for electrical and electronic equipment" was submitted to the IEC-CENELEC parallel vote and approved by CENELEC as EN IEC 60917-1:2019.

The following dates are fixed:

• latest date by which the document has to be implemented at national level by publication of an identical national standard or by endorsement	(dop)	2020-07-18
• latest date by which the national standards conflicting with the document have to be withdrawn	(dow)	2022-10-18

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Endorsement notice

The text of the International Standard IEC 60917-1:2019 was approved by CENELEC as a European Standard without any modification.

Annex ZA
(normative)

Normative references to international publications with their corresponding European publications

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE 1 Where an International Publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

NOTE 2 Up-to-date information on the latest versions of the European Standards listed in this annex is available here: www.cenelec.eu.

Publication	Year	Title	EN/HD	Year
IEC 60050-581	-	International Electrotechnical Vocabulary - Part 581: Electromechanical components for electronic equipment	-	-
IEC 60297	series	Dimensions of mechanical structures of the 482,6 mm (19 in) series	-	-
IEC 60297-3-100	-	Mechanical structures for electronic equipment - Dimensions of mechanical structures of the 482,6 mm (19 in) series - Part 3-100: Basic dimensions of front panels, subracks, chassis, racks and cabinets	EN 60297-3-100	-
IEC 60297-3-101	-	Mechanical structures for electronic equipment - Dimensions of mechanical structures of the 482,6 mm (19 in) series - Part 3-101: Subracks and associated plug-in units	EN 60297-3-101	-
IEC 60297-3-102	-	Mechanical structures for electronic equipment - Dimensions of mechanical structures of the 482,6 mm (19 in) series - Part 3-102: Injector/extractor handle	EN 60297-3-102	-
IEC 60297-3-103	-	Mechanical structures for electronic equipment - Dimensions of mechanical structures of the 482,6 mm (19 in) series - Part 3-103: Keying and alignment pin	EN 60297-3-103	-
IEC 60297-3-104	-	Mechanical structures for electronic equipment - Dimensions of mechanical structures of the 482,6 mm (19 in) series - Part 3-104: Connector dependent interface dimensions of subracks and plug-in units	EN 60297-3-104	-

Publication	Year	Title	EN/HD	Year
IEC 60297-3-105	-	Mechanical structures for electronic equipment - Dimensions of mechanical structures of the 482,6 mm (19 in) series - Part 3-105: Dimensions and design aspects for 1U high chassis	EN 60297-3-105	-
IEC 60297-3-106	-	Mechanical structures for electronic equipment - Dimensions of mechanical structures of the 482,6 mm (19 in) series - Part 3-106: Adaptation dimensions for subracks and chassis applicable with metric cabinets or racks in accordance with IEC 60917-2-1	EN 60297-3-106	-
IEC 60297-3-107	-	Mechanical structures for electronic equipment - Dimensions of mechanical structures of the 482,6 mm (19 in) series - Part 3-107: Dimensions of subracks and plug-in units, small form factor	EN 60297-3-107	-
IEC 60297-3-108	-	Mechanical structures for electronic equipment - Dimensions of mechanical structures of the 482,6 mm (19 in) series - Part 3-108: Dimensions of R-type subracks and plug-in units	EN 60297-3-108	-
IEC 60297-3-109	-	Mechanical structures for electrical and electronic equipment – Dimensions of mechanical structures of the 482,6 mm (19 in) series – Part 3-109: Dimensions of chassis for embedded computing devices	EN 60297-3-109	-
IEC 60297-3-110	-	Mechanical structures for electrical and electronic equipment - Dimensions of mechanical structures of the 482,6 mm (19 in) series - Part 3-110: Residential racks and cabinets for smart houses	EN IEC 60297-3-110	-
IEC/TR 60668	-	Dimensions of panel areas and cut-outs for panel and rack-mounted industrial-process measurement and control instruments	-	-
IEC 60917-2	-	Modular order for the development of mechanical structures for electronic equipment practices - Part 2: Sectional specification - Interface co-ordination dimensions for the 25 mm equipment practice	EN 60917-2	-
IEC 60917-2-1	-	Modular order for the development of mechanical structures for electronic equipment practices - Part 2: Sectional specification - Interface co-ordination dimensions for the 25 mm equipment practice - Section 1: Detail specification - Dimensions for cabinets and racks	EN 60917-2-1	-

Publication	Year	Title	EN/HD	Year
IEC 60917-2-2	-	Modular order for the development of mechanical structures for electronic equipment practices - Part 2: Sectional specification - Interface co-ordination dimensions for the 25 mm equipment practice - Section 2: Detail specification - Dimensions for subracks, chassis, backplanes, front panels and plug-in units	EN 60917-2-2	-
IEC 60917-2-3	-	Modular order for the development of mechanical structures for electronic equipment practices - Part 2-3: Sectional specification - Interface co-ordination dimensions for the 25 mm equipment practice - Extended detail specification - Dimensions for subracks, chassis, backplanes, front panels and plug-in units	EN 60917-2-3	-
IEC 60917-2-4	-	Modular order for the development of mechanical structures for electronic equipment practices - Part 2-4: Sectional specification - Interface co-ordination dimensions for the 25 mm equipment practice - Adaptation dimensions for subracks or chassis applicable in cabinets or racks in accordance with IEC 60297-3-100 (19 in)	EN 60917-2-4	-
IEC 60917-2-5	-	Modular order for the development of mechanical structures for electronic equipment practices - Part 2-5: Sectional specification - Interface co-ordination dimensions for the 25 mm equipment practice - Cabinet interface dimensions for miscellaneous equipment	EN 60917-2-5	-
IEC 61554	-	Panel mounted equipment - Electrical measuring instruments - Dimensions for panel mounting	-	-
IEC 61587	series	Mechanical structures for electronic equipment - Tests for IEC 60917 and IEC 60297 series	EN 61587	series
IEC 61969-1	-	Mechanical structures for electronic equipment - Outdoor enclosures - Part 1: Design guidelines	EN 61969-1	-
IEC 61969-2	-	Mechanical structures for electronic equipment - Outdoor enclosures - Part 2: Coordination dimensions	EN 61969-2	-
IEC 61969-3	-	Mechanical structures for electronic equipment - Outdoor enclosures - Part 3: Environmental requirements, tests and safety aspects	EN 61969-3	-
IEC 62194	-	Method of evaluating the thermal performance of enclosures	EN 62194	-

Publication	Year	Title	EN/HD	Year
IEC/TS 62454	-	Mechanical structures for electronic equipment - Design guide: Interface dimensions and provisions for water cooling of electronic equipment within cabinets of the IEC 60297 and IEC 60917 series	-	-
IEC 62610	series	Mechanical structures for electrical and electronic equipment – Thermal management for cabinets in accordance with IEC 60297 and IEC 60917 series	EN 62610	series
IEC Guide 103	1980	Guide on dimensional co-ordination	-	-
ISO 1006	-	Building construction; Modular coordination; Basic module	-	-
ISO 1040	-	Building construction - Modular coordination - Multimodules for horizontal coordinating dimensions	-	-
ISO 1791	-	Building construction - Modular co-ordination - Vocabulary	-	-
ISO 2848	-	Building construction - Modular coordination - Principles and rules	-	-
ISO 3394	-	Dimensions of rigid rectangular packages; Transport packages	-	-
ISO 3676	-		-	-
ISO 6514	-	Building construction - Modular coordination - Sub-modular increments	-	-
ISO 80000-1	2009	Quantities and units -- Part 1: General	EN ISO 80000-1	2013
ISO 80000-3	2006	Quantities and units -- Part 3: Space and time	EN ISO 80000-3	2013

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INTERNATIONAL STANDARD

NORME INTERNATIONALE

Modular order for the development of mechanical structures for electrical and electronic equipment practices –
Part 1: Generic standard

Ordre modulaire pour le développement des structures mécaniques pour les infrastructures électriques et électroniques –
Partie 1: Norme générique

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INTERNATIONAL ELECTROTECHNICAL COMMISSION

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MODULAR ORDER FOR THE DEVELOPMENT OF MECHANICAL STRUCTURES FOR ELECTRICAL AND ELECTRONIC EQUIPMENT PRACTICES –

Part 1: Generic standard

FOREWORD

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International Standard IEC 60917-1 has been prepared by subcommittee 48D: Mechanical structures for electrical and electronic equipment, of IEC technical committee 48: Electrical connectors and mechanical structures for electrical and electronic equipment.

This second edition cancels and replaces the first edition published in 1998 and its Amendment 1:2000. This edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to the previous edition:

a) added information on newly developed detail specification standards of mechanical structures for the electrical and electronic equipment practices;
b) added information on newly developed performance test standards for the verifications of environmental performances and safety aspects and issues of the thermal performance and thermal management for the electrical and electronic equipment practices;